

# 74LVT640

3.3 V Octal transceiver with direction pin; inverting; 3-state

Rev. 3 — 10 April 2017

Product data sheet

## 1 General description

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The 74LVT640 is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3 V.

This device is an octal transceiver featuring inverting 3-state bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features an output enable ( $\overline{OE}$ ) input for easy cascading and a direction (DIR) input for direction control.

## 2 Features and benefits

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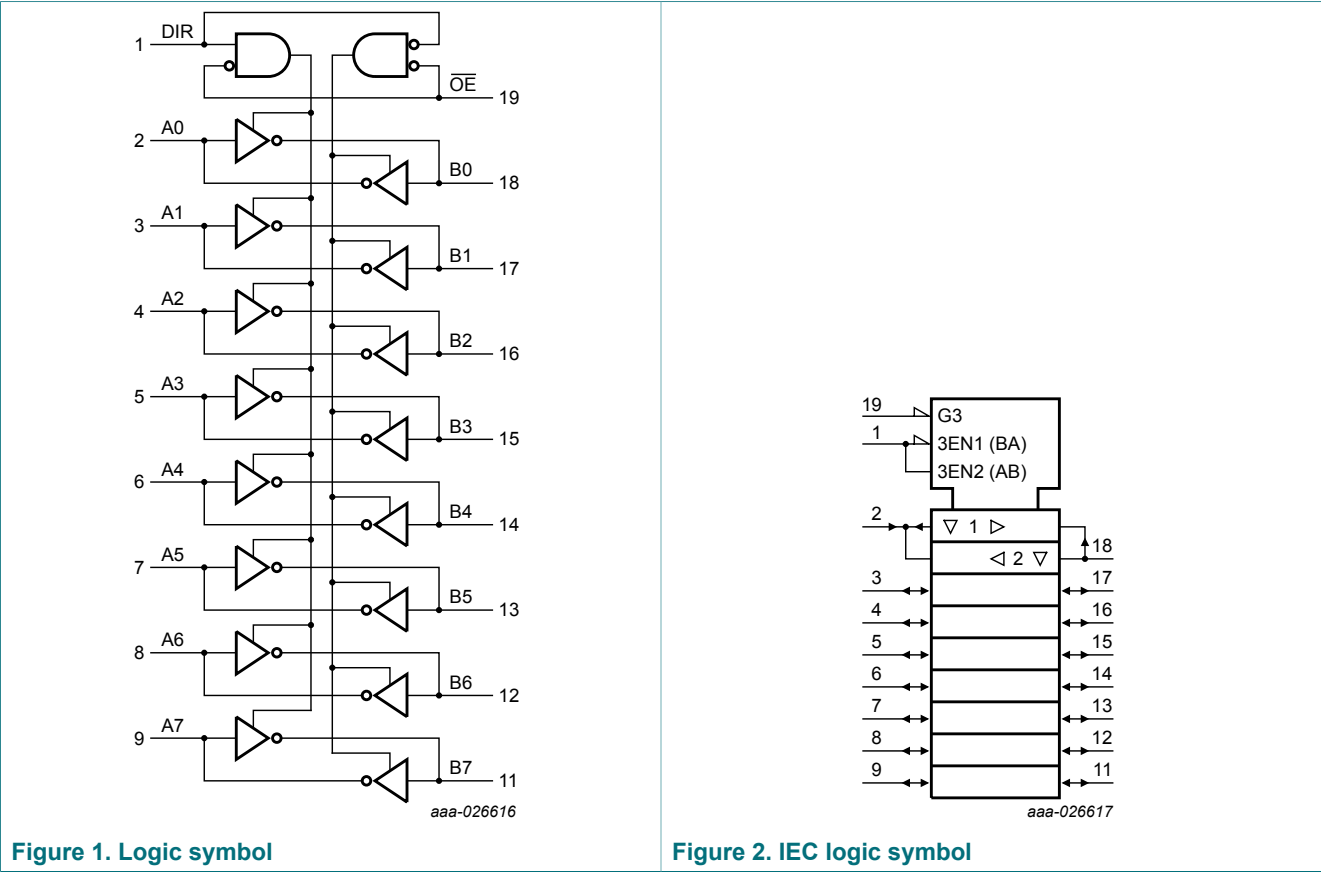
- 3-state buffers
- Octal bidirectional bus interface
- Input and output interface capability to systems at 5 V supply
- TTL input and output switching levels
- Output capability: +64 mA and -32 mA
- Bus-hold data inputs eliminate the need for external pull-up resistors for unused inputs
- Live insertion/extraction permitted
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- Latch-up protection:
  - JESD78: exceeds 500 mA
- ESD protection:
  - MIL STD 883 method 3015: exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V

3 Ordering information

Table 1. Ordering information

| Type number | Package           |         |                                                                        |          |
|-------------|-------------------|---------|------------------------------------------------------------------------|----------|
|             | Temperature range | Name    | Description                                                            | Version  |
| 74LVT640D   | -40 °C to +85 °C  | SO20    | plastic small outline package; 20 leads; body width 7.5 mm             | SOT163-1 |
| 74LVT640DB  | -40 °C to +85 °C  | SSOP20  | plastic shrink small outline package; 20 leads; body width 5.3 mm      | SOT339-1 |
| 74LVT640PW  | -40 °C to +85 °C  | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm | SOT360-1 |

4 Functional diagram



5 Pinning information

5.1 Pinning

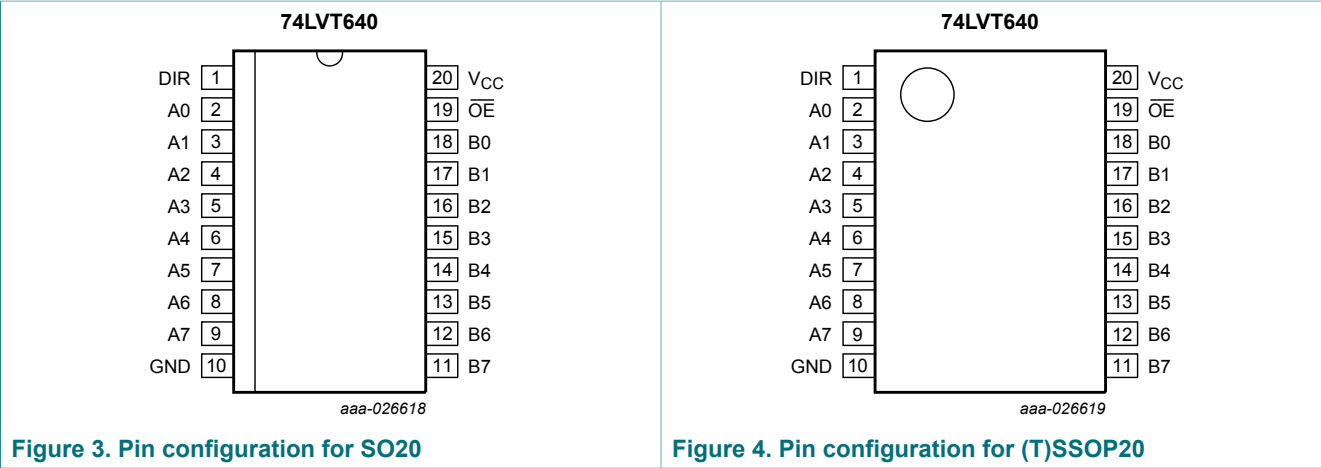


Figure 3. Pin configuration for SO20

Figure 4. Pin configuration for (T)SSOP20

5.2 Pin description

Table 2. Pin description

| Symbol                         | Pin                            | Description                      |
|--------------------------------|--------------------------------|----------------------------------|
| DIR                            | 1                              | direction control input          |
| A0, A1, A2, A3, A4, A5, A6, A7 | 2, 3, 4, 5, 6, 7, 8, 9         | data inputs/outputs              |
| GND                            | 10                             | ground (0 V)                     |
| B0, B1, B2, B3, B4, B5, B6, B7 | 18, 17, 16, 15, 14, 13, 12, 11 | data inputs/outputs              |
| OE                             | 19                             | output enable input (active LOW) |
| VCC                            | 20                             | supply voltage                   |

6 Functional description

Table 3. Function selection <sup>[1]</sup>

| Inputs |     | Inputs/outputs  |                 |
|--------|-----|-----------------|-----------------|
| OE     | DIR | An              | Bn              |
| L      | L   | $\overline{Bn}$ | inputs          |
| L      | H   | inputs          | $\overline{An}$ |
| H      | X   | Z               | Z               |

[1] H = HIGH voltage level;  
L = LOW voltage level;  
X = don't care;  
Z = high impedance OFF-state.

## 7 Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                                     | Min  | Max  | Unit |
|-----------|-------------------------|------------------------------------------------|------|------|------|
| $V_{CC}$  | supply voltage          |                                                | -0.5 | +4.6 | V    |
| $V_I$     | input voltage           | [1]                                            | -0.5 | +7.0 | V    |
| $V_O$     | output voltage          | output in OFF or HIGH state [1]                | -0.5 | +7.0 | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$                                      | -50  | -    | mA   |
| $I_{OK}$  | output clamping current | $V_O < 0$                                      | -50  | -    | mA   |
| $I_O$     | output current          | output in LOW state                            | -    | 128  | mA   |
|           |                         | output in HIGH state                           | -64  | -    | mA   |
| $T_{stg}$ | storage temperature     |                                                | -65  | +150 | °C   |
| $T_j$     | junction temperature    | [2]                                            | -    | 150  | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40\text{ °C to }+85\text{ °C}$ [3] | -    | 500  | mW   |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.  
For SSOP20 and TSSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.

## 8 Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                                               | Min | Max | Unit |
|---------------------|-------------------------------------|----------------------------------------------------------|-----|-----|------|
| $V_{CC}$            | supply voltage                      |                                                          | 2.7 | 3.6 | V    |
| $V_I$               | input voltage                       |                                                          | 0   | 5.5 | V    |
| $I_{OH}$            | HIGH-level output current           |                                                          | -   | -32 | mA   |
| $I_{OL}$            | LOW-level output current            |                                                          | -   | 32  | mA   |
|                     |                                     | current duty cycle $\leq 50\%$ ; $f_i \geq 1\text{ kHz}$ | -   | 64  | mA   |
| $T_{amb}$           | ambient temperature                 | in free air                                              | -40 | +85 | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | outputs enabled                                          | -   | 10  | ns/V |

## 9 Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter                          | Conditions                                                                                                                                                        | -40 °C to +85 °C      |                       |      | Unit |
|-----------------------|------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|-----------------------|------|------|
|                       |                                    |                                                                                                                                                                   | Min                   | Typ <sup>[1]</sup>    | Max  |      |
| V <sub>IK</sub>       | input clamping voltage             | V <sub>CC</sub> = 2.7 V; I <sub>IK</sub> = -18 mA                                                                                                                 | -1.2                  | -0.9                  | -    | V    |
| V <sub>IH</sub>       | HIGH-level input voltage           |                                                                                                                                                                   | 2.0                   | -                     | -    | V    |
| V <sub>IL</sub>       | LOW-level input voltage            |                                                                                                                                                                   | -                     | -                     | 0.8  | V    |
| V <sub>OH</sub>       | HIGH-level output voltage          | V <sub>CC</sub> = 2.7 V to 3.6 V; I <sub>OH</sub> = -100 µA                                                                                                       | V <sub>CC</sub> - 0.2 | V <sub>CC</sub> - 0.1 | -    | V    |
|                       |                                    | V <sub>CC</sub> = 2.7 V; I <sub>OH</sub> = -8 mA                                                                                                                  | 2.4                   | 2.5                   | -    | V    |
|                       |                                    | V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -32 mA                                                                                                                 | 2.0                   | 2.2                   | -    | V    |
| V <sub>OL</sub>       | LOW-level output voltage           | V <sub>CC</sub> = 2.7 V; I <sub>OL</sub> = 100 µA                                                                                                                 | -                     | 0.1                   | 0.2  | V    |
|                       |                                    | V <sub>CC</sub> = 2.7 V; I <sub>OL</sub> = 24 mA                                                                                                                  | -                     | 0.3                   | 0.5  | V    |
|                       |                                    | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 16 mA                                                                                                                  | -                     | 0.25                  | 0.4  | V    |
|                       |                                    | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 32 mA                                                                                                                  | -                     | 0.3                   | 0.5  | V    |
|                       |                                    | V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 64 mA                                                                                                                  | -                     | 0.4                   | 0.55 | V    |
| I <sub>I</sub>        | input leakage current              | control pins                                                                                                                                                      |                       |                       |      |      |
|                       |                                    | V <sub>CC</sub> = 0 V or 3.6 V; V <sub>I</sub> = 5.5 V                                                                                                            | -                     | 1                     | 10   | µA   |
|                       |                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND                                                                                                  | -                     | ±0.1                  | ±1   | µA   |
|                       |                                    | I/O data pins <sup>[2]</sup>                                                                                                                                      |                       |                       |      |      |
|                       |                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V                                                                                                                   | -                     | 1                     | 20   | µA   |
|                       |                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub>                                                                                                         | -                     | 0.1                   | 1    | µA   |
| I <sub>OFF</sub>      | power-off leakage current          | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V                                                                                                                     | -5                    | -1                    | -    | µA   |
|                       |                                    | V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 0 V to 4.5 V                                                                                            | -                     | 1                     | ±100 | µA   |
|                       |                                    | V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 0 V to 4.5 V                                                                                            | -                     | 1                     | ±100 | µA   |
| I <sub>CEX</sub>      | output high leakage current        | output in HIGH-state when V <sub>O</sub> > V <sub>CC</sub> ; V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 3.0 V                                                      | -                     | 60                    | 125  | µA   |
| I <sub>O(pu/pd)</sub> | power-up/power-down output current | V <sub>CC</sub> ≤ 1.2 V; V <sub>O</sub> = 0.5 V to V <sub>CC</sub> ; V <sub>I</sub> = GND or V <sub>CC</sub> ; $\overline{\text{OE}}$ = don't care <sup>[3]</sup> | -                     | 15                    | ±100 | µA   |
| I <sub>BHL</sub>      | bus hold LOW current               | V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 0.8 V <sup>[4]</sup>                                                                                                    | 75                    | 150                   | -    | µA   |
| I <sub>BHH</sub>      | bus hold HIGH current              | V <sub>CC</sub> = 3.0 V; V <sub>I</sub> = 2.0 V                                                                                                                   | -75                   | -150                  | -    | µA   |
| I <sub>BHLO</sub>     | bus hold LOW overdrive current     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V to 3.6 V                                                                                                            | 500                   | -                     | -    | µA   |
| I <sub>BHHO</sub>     | bus hold HIGH overdrive current    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V to 3.6 V                                                                                                            | -                     | -                     | -500 | µA   |
| I <sub>CC</sub>       | supply current                     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A                                                                            |                       |                       |      |      |
|                       |                                    | outputs HIGH                                                                                                                                                      | -                     | 0.13                  | 0.19 | mA   |
|                       |                                    | outputs LOW                                                                                                                                                       | -                     | 3                     | 12   | mA   |
|                       |                                    | outputs disabled                                                                                                                                                  | -                     | 0.13                  | 0.19 | mA   |

## 3.3 V Octal transceiver with direction pin; inverting; 3-state

| Symbol          | Parameter                 | Conditions                                                                                                                                     | -40 °C to +85 °C |                    |     | Unit |
|-----------------|---------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------------------|-----|------|
|                 |                           |                                                                                                                                                | Min              | Typ <sup>[1]</sup> | Max |      |
| $\Delta I_{CC}$ | additional supply current | per input pin; $V_{CC} = 3.0\text{ V}$ to $3.6\text{ V}$ ; one input = $V_{CC} - 0.6\text{ V}$ ; other inputs = $V_{CC}$ or GND <sup>[5]</sup> | -                | 0.1                | 0.2 | mA   |
| $C_I$           | input capacitance         | DIR and $\overline{OE}$ inputs; $V_I = 0\text{ V}$ or $3.0\text{ V}$                                                                           | -                | 4                  | -   | pF   |
| $C_{I/O}$       | input/output capacitance  | at input/output data pins, outputs disabled; $V_{I/O} = 0\text{ V}$ or $3.0\text{ V}$                                                          | -                | 7                  | -   | pF   |

[1] All typical values are measured at  $V_{CC} = 3.3\text{ V}$  (unless stated otherwise) and  $T_{amb} = 25\text{ °C}$ .

[2] Unused pins at  $V_{CC}$  or GND.

[3] This parameter is valid for any  $V_{CC}$  between  $0\text{ V}$  and  $1.2\text{ V}$  with a transition time of up to  $10\text{ ms}$ . From  $V_{CC} = 1.2\text{ V}$  to  $V_{CC} = 3.0\text{ V}$  to  $3.6\text{ V}$  a transition time of  $100\text{ ms}$  is permitted. This parameter is valid for  $T_{amb} = +25\text{ °C}$  only.

[4] This is the bus hold overdrive current required to force the input to the opposite logic state.

[5] This is the increase in supply current for each input at the specified voltage level other than  $V_{CC}$  or GND.

## 10 Dynamic characteristics

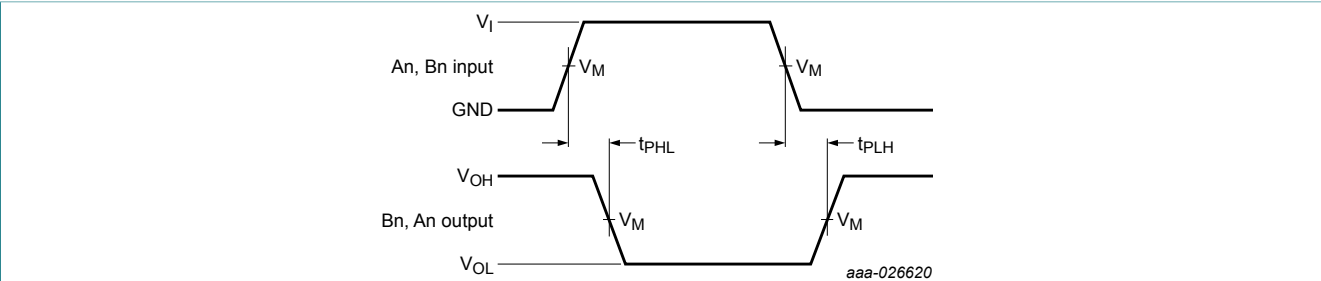
**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 7](#).

| Symbol    | Parameter                           | Conditions                                                | -40 °C to +85 °C |                    |     | Unit |
|-----------|-------------------------------------|-----------------------------------------------------------|------------------|--------------------|-----|------|
|           |                                     |                                                           | Min              | Typ <sup>[1]</sup> | Max |      |
| $t_{PLH}$ | LOW to HIGH propagation delay       | An to Bn or Bn to An; see <a href="#">Figure 5</a>        |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 4.5 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 1.0              | 2.3                | 3.7 | ns   |
| $t_{PHL}$ | HIGH to LOW propagation delay       | An to Bn or Bn to An; see <a href="#">Figure 5</a>        |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 3.1 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 1.0              | 2.4                | 3.3 | ns   |
| $t_{PZH}$ | OFF-state to HIGH propagation delay | $\overline{OE}$ to An or Bn; see <a href="#">Figure 6</a> |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 6.9 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 1.1              | 3.5                | 5.3 | ns   |
| $t_{PZL}$ | OFF-state to LOW propagation delay  | $\overline{OE}$ to An or Bn; see <a href="#">Figure 6</a> |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 6.2 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 1.5              | 3.6                | 5.3 | ns   |
| $t_{PHZ}$ | HIGH to OFF-state propagation delay | $\overline{OE}$ to An or Bn; see <a href="#">Figure 6</a> |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 5.6 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 2.2              | 3.7                | 5.0 | ns   |
| $t_{PLZ}$ | LOW to OFF-state propagation delay  | $\overline{OE}$ to An or Bn; see <a href="#">Figure 6</a> |                  |                    |     |      |
|           |                                     | $V_{CC} = 2.7\text{ V}$                                   | -                | -                  | 4.5 | ns   |
|           |                                     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$                  | 2.0              | 3.1                | 4.5 | ns   |

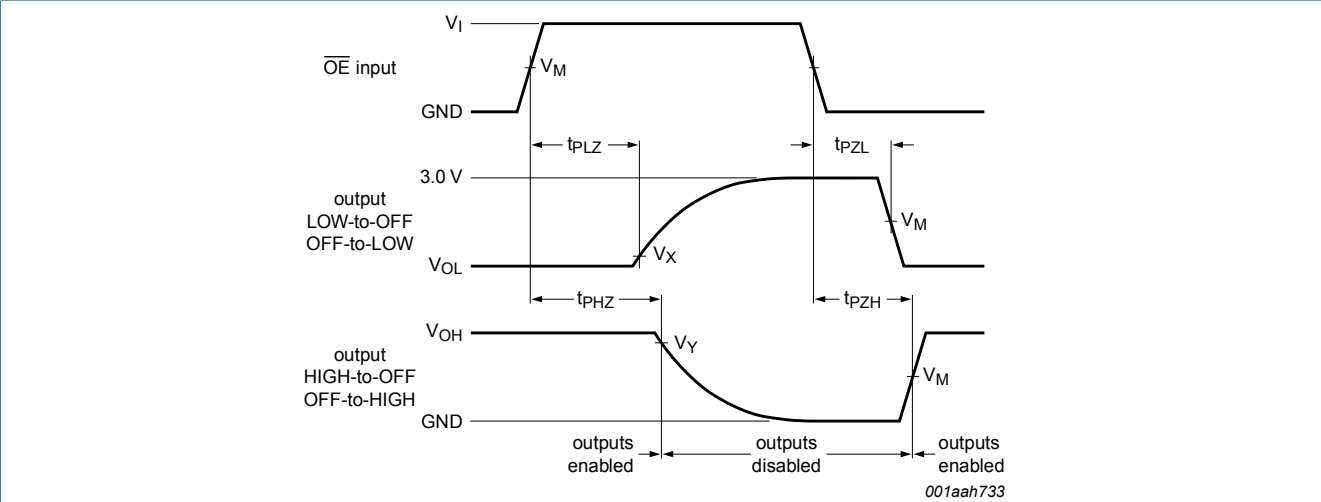
[1] Typical values are measured at  $T_{amb} = 25\text{ °C}$  and  $V_{CC} = 3.3\text{ V}$

10.1 Waveforms and test circuit



See [Table 8](#) for measurement points.  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Figure 5. Input (An, Bn) to output ( $\overline{Bn}$ ,  $\overline{An}$ ) propagation delays



See [Table 8](#) for measurement points.  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Figure 6. 3-state output enable and disable times

Table 8. Measurement points

| Input        |       | Output |                         |                         |
|--------------|-------|--------|-------------------------|-------------------------|
| $V_I$        | $V_M$ | $V_M$  | $V_x$                   | $V_y$                   |
| GND to 2.7 V | 1.5 V | 1.5 V  | $V_{OL} + 0.3\text{ V}$ | $V_{OH} - 0.3\text{ V}$ |

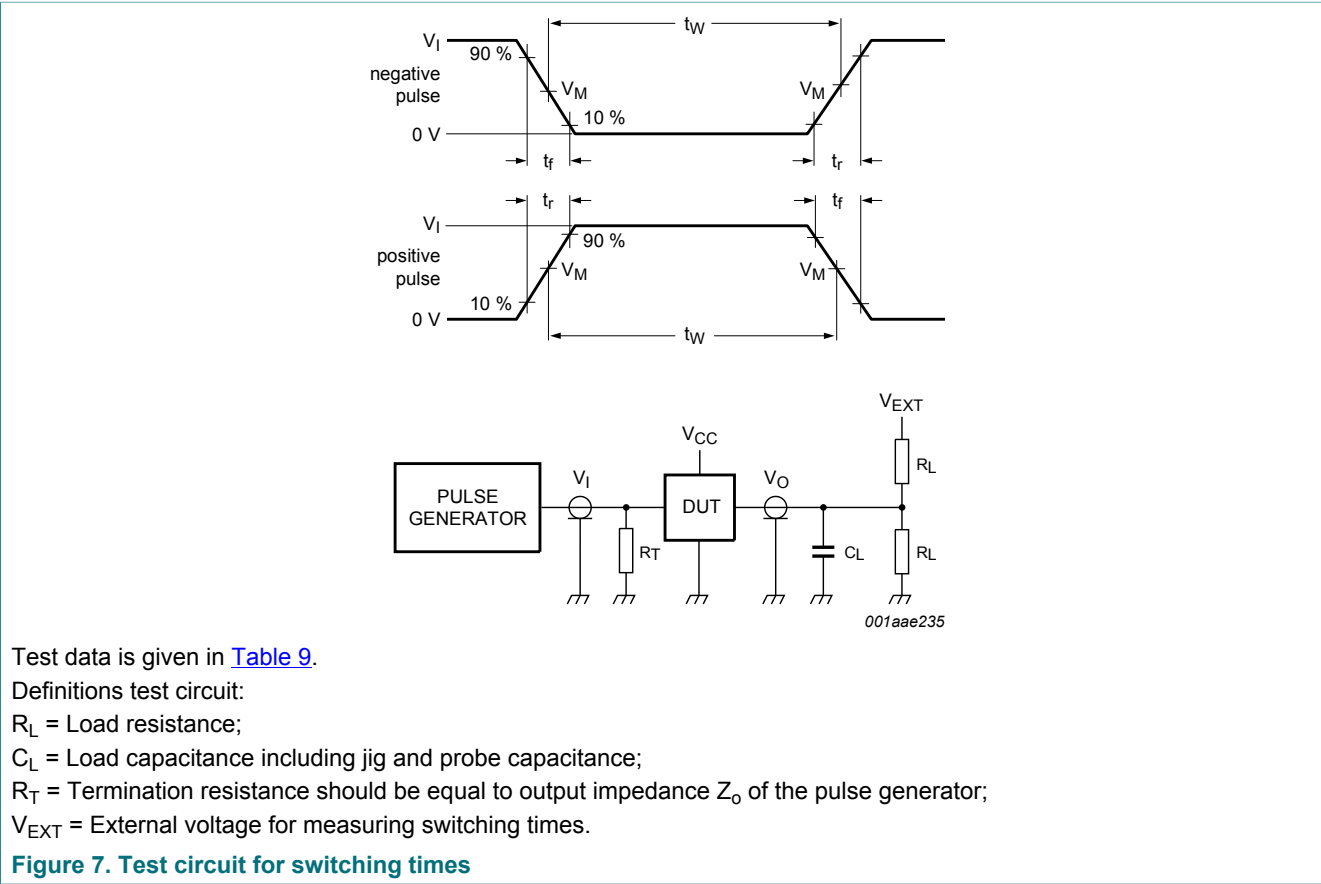


Table 9. Test data

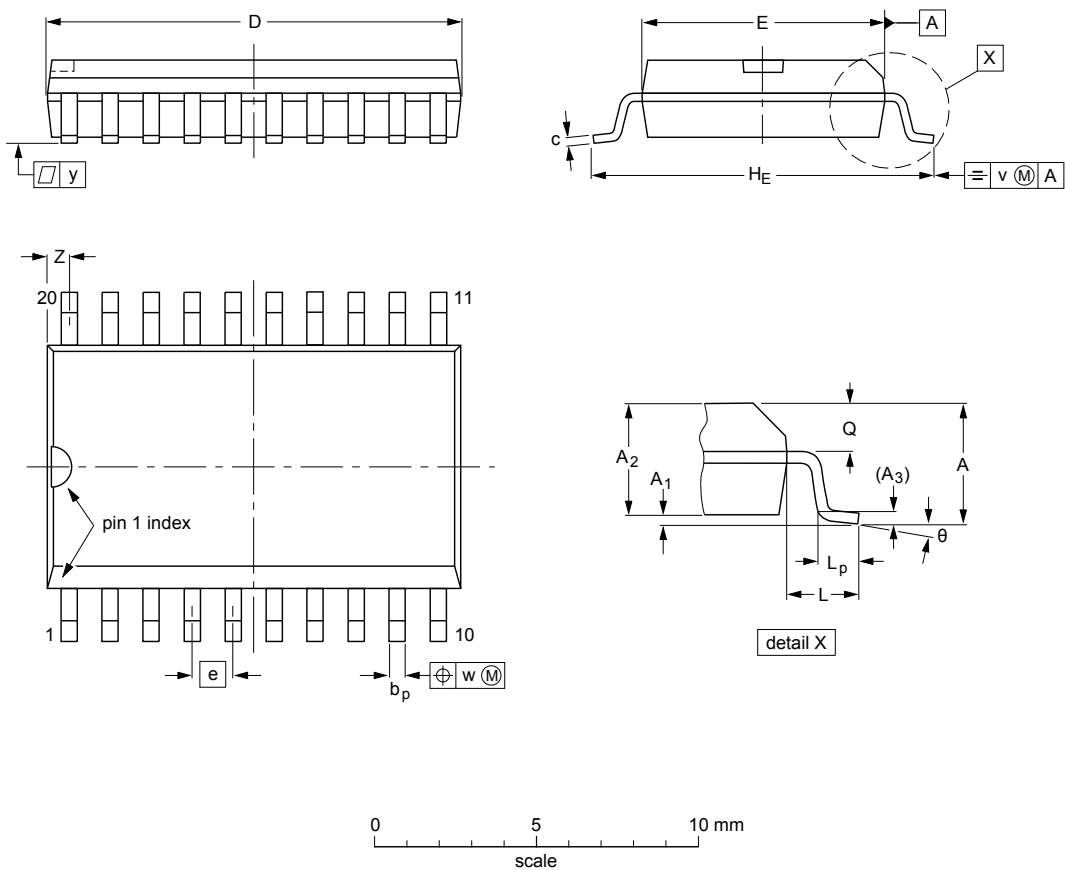
| Input |               |        |               | Load         |       | $V_{EXT}$          |                    |                    |
|-------|---------------|--------|---------------|--------------|-------|--------------------|--------------------|--------------------|
| $V_I$ | $f_i$         | $t_W$  | $t_r, t_f$    | $R_L$        | $C_L$ | $t_{PHZ}, t_{PZH}$ | $t_{PLZ}, t_{PZL}$ | $t_{PLH}, t_{PHL}$ |
| 2.7 V | $\leq 10$ MHz | 500 ns | $\leq 2.5$ ns | 500 $\Omega$ | 50 pF | GND                | 6 V                | open               |



11 Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | θ        |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 2.65      | 0.3<br>0.1     | 2.45<br>2.25   | 0.25           | 0.49<br>0.36   | 0.32<br>0.23   | 13.0<br>12.6     | 7.6<br>7.4       | 1.27 | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0     | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8°<br>0° |
| inches | 0.1       | 0.012<br>0.004 | 0.096<br>0.089 | 0.01           | 0.019<br>0.014 | 0.013<br>0.009 | 0.51<br>0.49     | 0.30<br>0.29     | 0.05 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 | 0.043<br>0.039 | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   |          |

Note

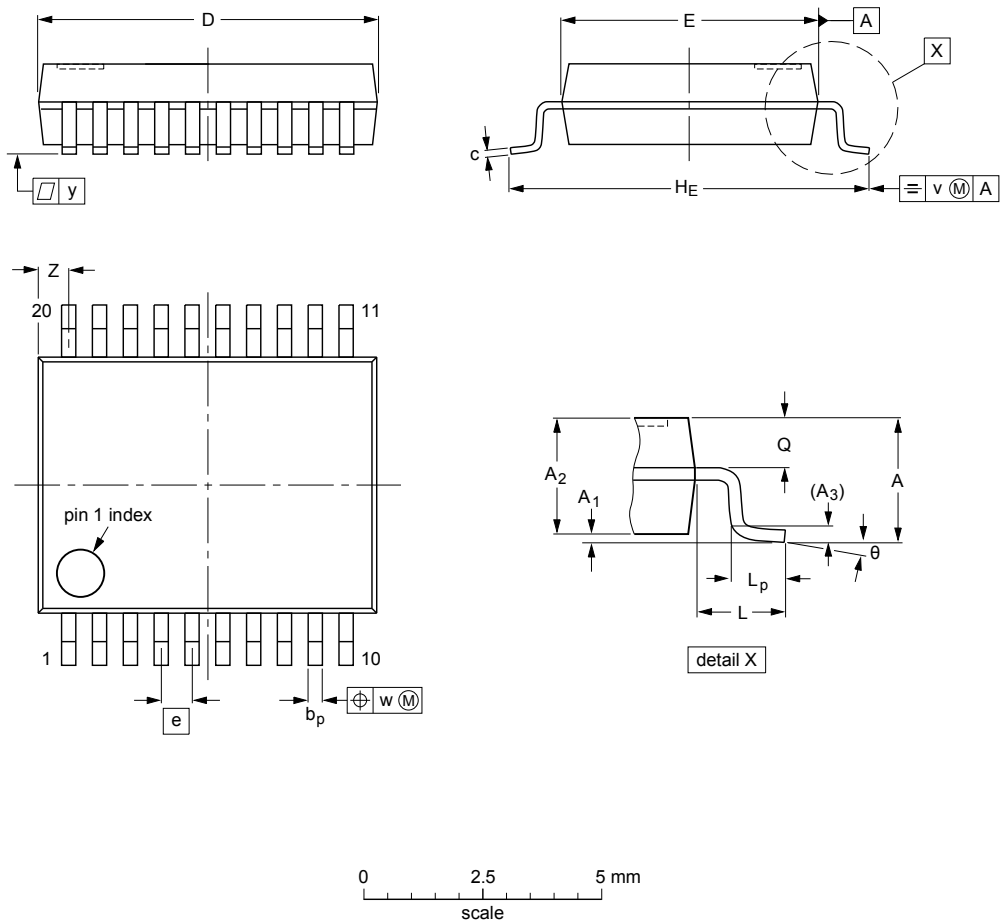
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT163-1           | 075E04     | MS-013 |       |  |                        | 99-12-27<br>03-02-19 |

Figure 8. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A <sub>max.</sub> | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c            | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L    | L <sub>p</sub> | Q          | v   | w    | y   | Z <sup>(1)</sup> | θ        |
|------|-------------------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm   | 2                 | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25   | 0.20<br>0.09 | 7.4<br>7.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6     | 1.25 | 1.03<br>0.63   | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 0.9<br>0.5       | 8°<br>0° |

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT339-1           |            | MO-150 |       |  |                        | 99-12-27<br>03-02-19 |

Figure 9. Package outline SOT339-1 (SSOP20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

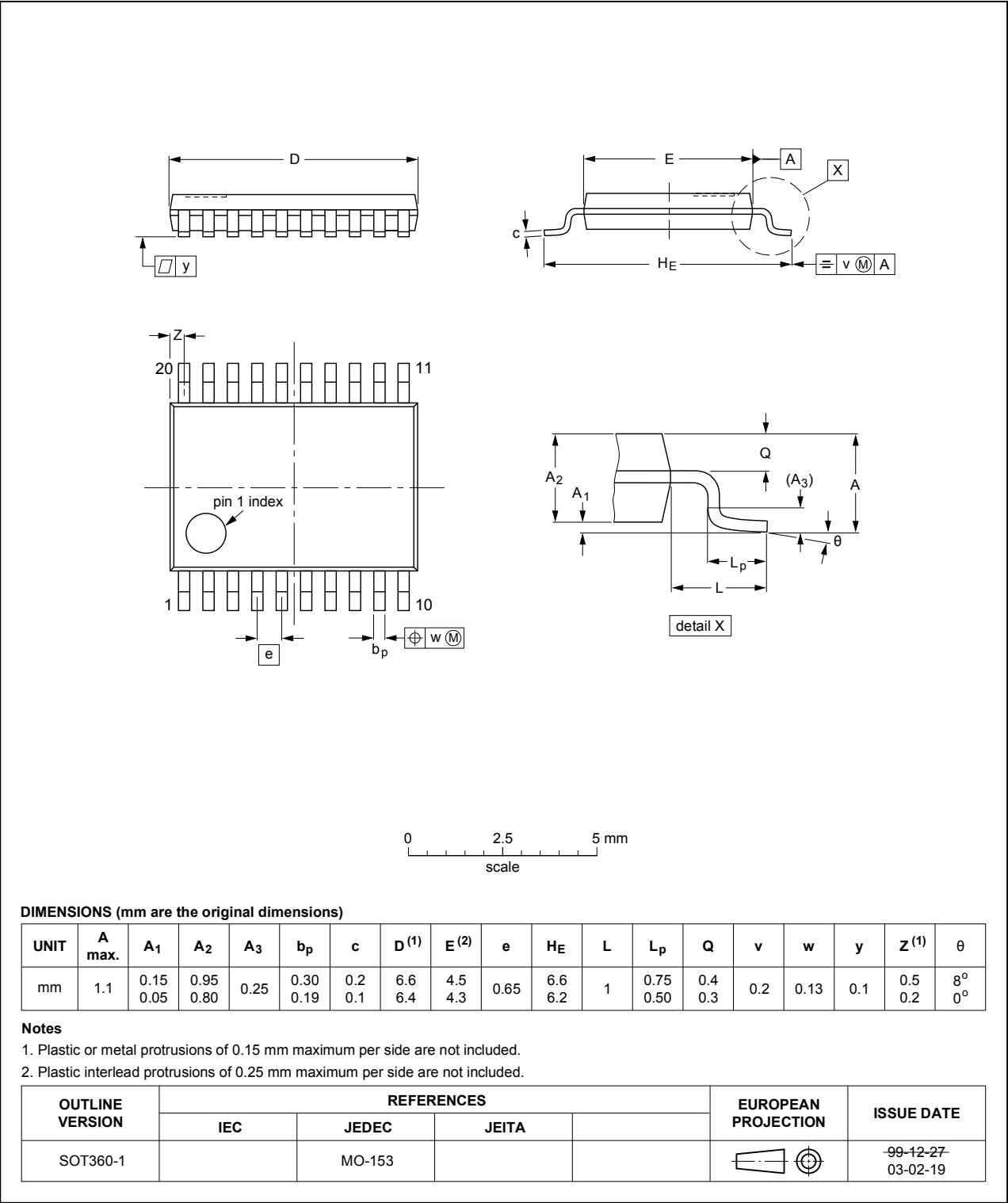


Figure 10. Package outline SOT360-1 (TSSOP20)

## 12 Abbreviations

Table 10. Abbreviations

| Acronym | Description                                     |
|---------|-------------------------------------------------|
| BiCMOS  | Bipolar Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                               |
| ESD     | ElectroStatic Discharge                         |
| MIL     | Military                                        |
| MM      | Machine Model                                   |
| TTL     | Transistor-Transistor Logic                     |

## 13 Revision history

Table 11. Revision history

| Document ID    | Release date                                                                                                                                                                                                                           | Data sheet status     | Change notice | Supersedes   |
|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|--------------|
| 74LVT640 v.3   | 20170410                                                                                                                                                                                                                               | Product data sheet    | -             | 74LVT640 v.2 |
| Modifications: | <ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li><li>Legal texts have been adapted to the new company name where appropriate.</li></ul> |                       |               |              |
| 74LVT640 v.2   | 19980219                                                                                                                                                                                                                               | Product specification | -             | 74LVT640 v.1 |
| 74LVT640 v.1   | 19961001                                                                                                                                                                                                                               | Product specification | -             | -            |

## 14 Legal information

### 14.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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### 3.3 V Octal transceiver with direction pin; inverting; 3-state

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